Sergio Ferrero

List of Publications by Year in descending order

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46 1,112 16 32 papers citations h-index g-index

46 46 46 1496
all docs docs citations times ranked citing authors

#	Article	IF	CITATIONS
1	<i>In situ</i> MoS ₂ Decoration of Laser-Induced Graphene as Flexible Supercapacitor Electrodes. ACS Applied Materials & Samp; Interfaces, 2016, 8, 10459-10465.	8.0	228
2	Inkjet printing and low power laser annealing of silver nanoparticle traces for the realization of low resistivity lines for flexible electronics. Microelectronic Engineering, 2011, 88, 2481-2483.	2.4	106
3	Deep levels by proton and electron irradiation in 4H–SiC. Journal of Applied Physics, 2005, 98, 053706.	2.5	104
4	New insights on laser-induced graphene electrodes for flexible supercapacitors: tunable morphology and physical properties. Nanotechnology, 2017, 28, 174002.	2.6	80
5	A novel highly electrically conductive composite resin for stereolithography. Materials Today Communications, 2019, 19, 12-17.	1.9	58
6	Boosting Electric Double Layer Capacitance in Laserâ€Induced Grapheneâ€Based Supercapacitors. Advanced Sustainable Systems, 2022, 6, 2100228.	5. 3	58
7	Rapid prototyping of 3D Organic Electrochemical Transistors by composite photocurable resin. Scientific Reports, 2020, 10, 13335.	3.3	43
8	SERS active silver nanoparticles synthesized by inkjet printing on mesoporous silicon. Nanoscale Research Letters, 2014, 9, 527.	5.7	40
9	PLA conductive filament for 3D printed smart sensing applications. Rapid Prototyping Journal, 2018, 24, 739-743.	3.2	32
10	4H-SiC Schottky Barrier Diodes Using Mo-, Ti- and Ni-Based Contacts. Materials Science Forum, 0, 615-617, 647-650.	0.3	30
11	A novel smart caliper foam pig for low-cost pipeline inspectionâ€"Part A: Design and laboratory characterization. Journal of Petroleum Science and Engineering, 2015, 127, 311-317.	4.2	30
12	Hydrogenated amorphous silicon carbon alloys for solar cells. Thin Solid Films, 2002, 403-404, 349-353.	1.8	26
13	A polymer Lab-on-a-Chip for genetic analysis using the arrayed primer extension on microarray chips. Biomedical Microdevices, 2014, 16, 661-670.	2.8	26
14	Defect characterization of 4H-SiC wafers for power electronic device applications. Journal of Physics Condensed Matter, 2002, 14, 13397-13402.	1.8	21
15	3D-printed microfluidics on thin poly(methyl methacrylate) substrates for genetic applications. Journal of Vacuum Science and Technology B:Nanotechnology and Microelectronics, 2018, 36, .	1.2	18
16	3D Printing with the Commercial UV-Curable Standard Blend Resin: Optimized Process Parameters towards the Fabrication of Tiny Functional Parts. Polymers, 2019, 11, 292.	4.5	18
17	Growth and characterization of SiC layers obtained by microwave-CVD. Thin Solid Films, 2001, 383, 169-171.	1.8	17
18	A novel smart caliper foam pig for low-cost pipeline inspection – Part B: Field test and data processing. Journal of Petroleum Science and Engineering, 2015, 133, 771-775.	4.2	17

#	Article	IF	Citations
19	Properties of a-SiC:H films deposited in high power regime. Thin Solid Films, 2003, 427, 279-283.	1.8	16
20	Low temperature electric transport properties in hydrogenated microcrystalline silicon films. Thin Solid Films, 2007, 515, 7629-7633.	1.8	14
21	Large area microcrystalline silicon films grown by ECR-CVD. Thin Solid Films, 2001, 383, 181-184.	1.8	13
22	Structural and electrical characterization of epitaxial 4H–SiC layers for power electronic device applications. Materials Science and Engineering B: Solid-State Materials for Advanced Technology, 2003, 102, 298-303.	3.5	13
23	Series resistance study of Schottky diodes developed on 4H-SiC wafers using a contact of titanium or molybdenum. Microelectronic Engineering, 2013, 106, 43-47.	2.4	11
24	Laserâ€Induced Graphenization of PDMS as Flexible Electrode for Microsupercapacitors. Advanced Materials Interfaces, 2021, 8, 2101046.	3.7	11
25	Surface analysis and defect characterization of 4H–SiC wafers for power electronic device applications. Diamond and Related Materials, 2003, 12, 1224-1226.	3.9	10
26	Fabrication of microstructures on glass by imprinting in conventional furnace for lab-on-chip application. Microelectronic Engineering, 2012, 95, 90-101.	2.4	10
27	High-Voltage Temperature Humidity Bias Test (HV-THB): Overview of Current Test Methodologies and Reliability Performances. Electronics (Switzerland), 2020, 9, 1884.	3.1	9
28	Low temperature growth of SiO2 on SiC by plasma enhanced chemical vapor deposition for power device applications. Thin Solid Films, 2003, 427, 142-146.	1.8	6
29	Fabrication of large-area microfluidics structures on glass by imprinting and diode-pumped solid state laser writing techniques. Microsystem Technologies, 2011, 17, 1611-1619.	2.0	6
30	Evaluation of Correct Value of Richardson's Constant by Analyzing the Electrical Behavior of Three Different Diodes at Different Temperatures. Materials Science Forum, 0, 711, 174-178.	0.3	6
31	Optical and structural properties of SiC layers grown by an electron cyclotron resonance CVD technique. Diamond and Related Materials, 2001, 10, 1264-1267.	3.9	5
32	Singleâ€Step 3D Printing of Silverâ€Patterned Polymeric Devices for Bacteria Proliferation Control. Macromolecular Materials and Engineering, 0, , 2100596.	3.6	5
33	a-Si:H based two-dimensional photonic crystals. Physica E: Low-Dimensional Systems and Nanostructures, 2003, 16, 539-543.	2.7	4
34	Barrier Inhomogeneities of a Medium Size Mo/4H-SiC Schottky Diode. Materials Science Forum, 2012, 711, 188-192.	0.3	4
35	Plasma-assisted SiC oxidation for power device fabrication. Applied Surface Science, 2004, 238, 336-340.	6.1	3
36	Multilayer film passivation for enhanced reliability of power semiconductor devices. Journal of Vacuum Science and Technology B:Nanotechnology and Microelectronics, 2020, 38, .	1.2	3

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37	Study of the optical properties and the density-of-states distribution of hydrogenated amorphous silicon-nitrogen alloy. The Philosophical Magazine: Physics of Condensed Matter B, Statistical Mechanics, Electronic, Optical and Magnetic Properties, 2001, 81, 1951-1962.	0.6	2
38	Fabrication of microstructures on nickel alloy by DPSS laser ablation technique for lab-on-chip applications. , $2010, , .$		2
39	Nanostructured silicon carbon thin films grown by plasma enhanced chemical vapour deposition technique. Thin Solid Films, 2013, 543, 27-31.	1.8	2
40	Back plate electroplating for high aspect ratio processes. Microelectronics International, 2017, 34, 69-74.	0.6	2
41	Silicon–carbon films deposited at low substrate temperature. Journal of Non-Crystalline Solids, 2006, 352, 1371-1375.	3.1	1
42	Schottky Contacts to N-Type 4H-SiC Fabricated with Ti-, Mo-, Ni- and Al-Based Metallizations. Materials Science Forum, 0, 679-680, 453-456.	0.3	1
43	Fabrication of microstructures on different materials by diode-pumped solid state laser writing for microfluidics applications. Microsystem Technologies, 2013, 19, 1185-1194.	2.0	1
44	Study of the Electrical Characteristics of the CNT/SiC Interface. Materials Science Forum, 2009, 615-617, 231-234.	0.3	0
45	Barrier Inhomogeneities of Mo Schottky Barrier Diodes on 4H-SiC. Materials Science Forum, 0, 645-648, 227-230.	0.3	0
46	Production of a thin diamond target by LASER for nuclear reactions inside storage rings. Journal of Radioanalytical and Nuclear Chemistry, 2015, 305, 737-742.	1.5	0